

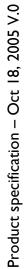
DATA SHEET

TRIMMABLE CHIP RESISTORS

TR series (Pb Free) 0/-10%, 0/-20%, 0/-30%

sizes 0402/0603/0805/1206







YAGEO



Chip Resistor Surface Mount

SERIES

0402 to 1206 (Pb Free)

SCOPE

This specification describes TR0402/0603/0805/1206 trimmable chip resistors with lead-free terminations made by thick film process.

ORDERING INFORMATION

Part number is identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO ORDERING CODE

CTC CODE

TR XXXX X X X XX XXXX L

(1) (2) (3) (4) (5) (6) (7)

(I) SIZE

0402/0603/0805/1206

(2) TOLERANCE

K = 0/-10%

M = 0/-20%

N = 0/-30%

(3) PACKAGING TYPE

R = Paper/PE taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(5) TAPING REEL

07 = 7 inch dia, Reel

7T = European type (d)

(6) RESISTANCE VALUE

5R6, 56R, 560R, 56K, IM, IOM.

(7) RESISTOR TERMINATIONS (a)

L = Lead-free terminations (matte tin)

APPLICATIONS

- Hand-held measuring equipment
- Mobile phones
- Camcorders
- Portable radios, CD and cassette
- Tuners
- Photo sensors

ORDERING EXAMPLE

The ordering code of a TR0603 chip resistor, value 330 Ω with 0/-30% tolerance, supplied in 7-inch tape reel is: TR0603NR-07330RL.

For size 1206 of European type resistor, value 330 Ω with 0/-30% tolerance, supplied in 7-inch tape reel, the ordering code is: TR1206NR-7T330RL.

NOTE

- a. The "L" at the end of the code is only for ordering. On the reel label, the standard CTC or I2NC will be mentioned an additional stamp "LFP"= lead free production.
- Products with lead in terminations fulfil the same requirements as mentioned in this datasheet.
- Products with lead in terminations will be phased out in the coming months (before July 1st, 2006)
- European type products are covered with transparent lacquer in stead of transparent glass layer.





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MARKING

TR0402/0603/0805/1206



For marking codes, please see EIA-marking code rules in data sheet "Chip resistors marking".

CONSTRUCTION

The resistors are constructed on a high-grade ceramic body (aluminium oxide). Internal metal electrodes are added at each end and a connection is made between them using a resistive metal glaze; the approximate resistor values are dependent on the composition of the glaze.

The resistive layer is covered with a translucent protective coat. Finally, two end electrodes are added, the composition of which has been designed to provide ease of soldering. See fig. 2.

DIMENSIONS

Table I For outlines see fig. 2

TYPE
L (mm)
W (mm)
H (mm)
 I_1 (mm)
 I_2 (mm)

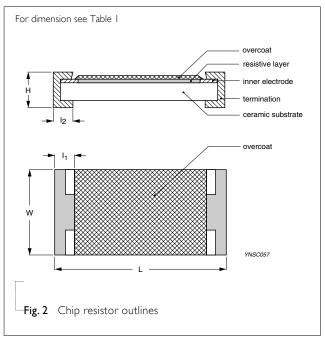
TR0402
 1.00 ± 0.10 0.50 ± 0.05 0.35 ± 0.05 0.20 ± 0.10 0.25 ± 0.10

TR0603
 1.60 ± 0.10 0.80 ± 0.10 0.45 ± 0.10 0.25 ± 0.15 0.25 ± 0.15

TR0805
 2.00 ± 0.10 1.25 ± 0.10 0.50 ± 0.10 0.35 ± 0.20 0.35 ± 0.20

TR1206
 3.10 ± 0.10 1.60 ± 0.10 0.55 ± 0.10 0.45 ± 0.20 0.40 ± 0.20

OUTLINES







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ELECTRICAL CHARACTERISTICS

Table 2

		CHARACTERISTICS					
TYPE	resistance range	Rated Power	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Temperature Coefficient of Resistance
TR0402	0/-10%, 0/-20%, 0/-30%: I Ω to 10 MΩ (E-24)	1/16 W	−55 °C to	50 V	100 V	100 V	
TR0603		1/16 W	+125 °C	50 V	100 V	100 V	$1 \Omega \le R \le 10 \Omega$: $\pm 200 \text{ ppm/°C}$
TR0805		1/8 W	−55 °C to	150 V	300 V	500 V	$10 \Omega < R ≤ 1 MΩ: ±100 ppm/°C$ 1 MΩ < R ≤ 10 MΩ: ±200 ppm/°C
TR1206		1/4 W	+155 °C	200 V	500 V	500 V	

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

ENVIRONMENTAL DATA

For material declaration information (IMDS-data) of the products, please see the separated info "Environmental data" conformed to EU RoHS.

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	TR0402	TR0603	TR0805	TR1206
Paper/PE taping reel (R)	7" (178 mm)	10,000	5,000	5,000	5,000

NOTE

1. For Paper/PE tape and reel specification/dimensions, please see the special data sheet "Packing" document.





FUNCTIONAL DESCRIPTION

PRODUCT CHARACTERIZATION

Standard values of nominal resistance are taken from the E24 series for resistors with a tolerance of 0/-10%, 0/-20% and 0/-30%. The values of the E24 series are in accordance with "IEC publication 60063".

OPERATING TEMPERATURE RANGE

Each type range:

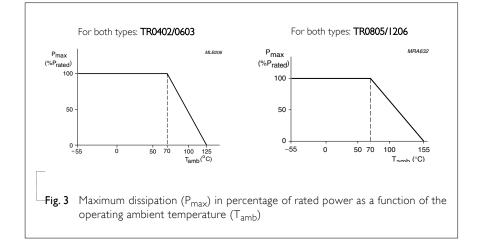
TR0402/0603: -55°C to +125°C; TR0805/1206: -55°C to +155°C.

LIMITING VALUES

Table 4						
TYPE	LIMITING VOLTAGE (V) ⁽¹⁾	LIMITING POWER (W)				
TR0402	50	1/16				
TR0603	50	1/16				
TR0805	150	1/8				
TR1206	200	1/4				

NOTES

 The maximum voltage that may be continuously applied to the resistor element, see "IEC publication 60115-8".



POWER RATING

Each type rated power at 70°C:

TR0402=1/16 W; TR0603=1/16 W; TR0805=1/8 W; TR1206=1/4 W.

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$

APPLICATION INFORMATION

TRIMMING INSTRUCTIONS WITH YAG-LASER

Typical values for:

Cutting speed = 10 to 300 mm/s

Laser power = I to 6 W

Maximum trimming length = 60% of resistor film width

Minimum distance between end termination and trimming cut =

TR0402/0603: 0.20 mm TR0805/1206: 0.50 mm

PROTECTION OF LASER CUT

With epoxy-phenol lacquers, epoxy resins or silicon alkyd-resins.

This is necessary for humidity tests and stability at load.



TESTS AND REQUIREMENTS

Table 5 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS	
Temperature	MIL-STD-202F-method 304;	At +25/–55 °C and +25/+125 °C	Refer to table 2	
Coefficient of Resistance	JIS C 5202-4.8	Formula:		
(T.C.R.)		T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$		
		Where		
		t ₁ =+25 °C or specified room temperature		
		t ₂ =–55 °C or +125 °C test temperature		
		R ₁ =resistance at reference temperature in ohms		
		R ₂ =resistance at test temperature in ohms		
Thermal Shock	MIL-STD-202F-method 107G; IEC 60115-1 4.19	At -65 (+0/-10) °C for 2 minutes and at UCT (+10/-0) °C for 2 minutes; 25 cycles	±(1.0%+0.05 Ω)	
		UCT: 0402/0603: 125 °C 0805/1206: 155 °C		
Low	MIL-R-55342D-Para 4.7.4	At -65 (+0/-5) °C for I hour; RCWV applied	±(1.0%+0.05 Ω)	
Temperature Operation		for 45 (+5/–0) minutes	No visible damage	
Short Time	MIL-R-55342D-Para 4.7.5;	2.5 × RCWV applied for 5 seconds at room	±(1.0%+0.05 Ω)	
Overload	IEC 60115-1 4.13	temperature	No visible damage	
Insulation	MIL-STD-202F-method 302;	One DC voltage (V) applied for 1 minute	≥10 GΩ	
Resistance	IEC 60115-1 4.6.1.1	Details see below table 6		
Dielectric	MIL-STD-202F-method 301;	One AC voltage (V _{ms}) applied for 1 minute	No breakdown or flashover	
Withstand Voltage	IEC 60115-1 4.6.1.1	Details see below table 6		
Resistance to	MIL-STD-202F-method 210C;	Unmounted chips; 260 \pm 5 °C for 10 \pm 1	±(1.0%+0.05 Ω)	
Soldering Heat	IEC 60115-1 4.18	seconds	No visible damage	
Life	MIL-STD-202F-method 108A;	At 70±2 °C for 1,000 hours; RCWV applied for	±(1.0%+0.05 Ω)	
	IEC 60115-1 4.25.1	1.5 hours on and 0.5 hour off		



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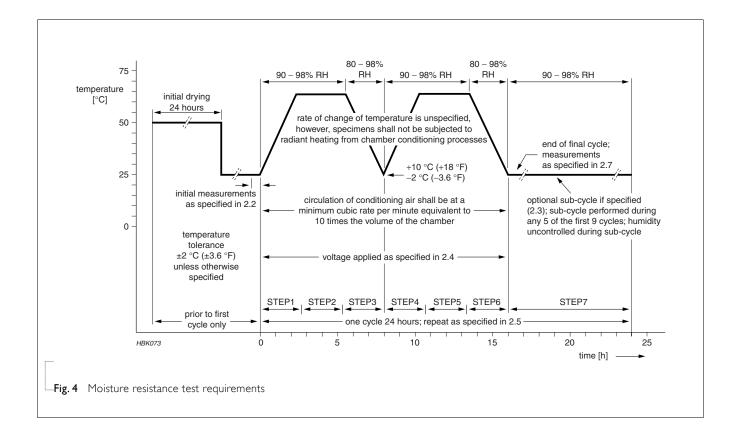
Table 5 Test condition, procedu	e and requirements	(continued)
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EST	TEST METHOD	PROCEDURE	REQUIREMENTS	
Solderability	MIL-STD-202F-method 208A;	Solder bath at 245±3 °C	Well tinned (≥95% covered)	
	IEC 60115-1 4.17	Dipping time: 2±0.5 seconds	No visible damage	
Bending	JIS C 5202.6.14;	Resistors mounted on a 90 mm glass epoxy	$\pm (1.0\% + 0.05 \ \Omega)$ No visible damage	
Strength	IEC 60115-1 4.15	resin PCB (FR4)		
		Bending: 5 mm		
Resistance to	MIL-STD-202F-method 215;	Isopropylalcohol (C ₃ H ₇ OH) or dichloromethane	No smeared	
Solvent	IEC 60115-1 4.29	(CH ₂ Cl ₂) followed by brushing		
Noise	JIS C 5202 5.9;	Maximum voltage (V _{ms}) applied	Resistors range Valu	
	IEC 60115-1 4.12		R < 100 Ω	10 df
			$100 \Omega \le R < 1 K\Omega$	20 dl
			$I K\Omega \le R < I0 K\Omega$	30 dl
			$10 \text{ K}\Omega \leq R < 100 \text{ K}\Omega$	40 d
			$100 \text{ K}\Omega \leq R < 1 \text{ M}\Omega$	46 d
			$I M\Omega \le R \le 22 M\Omega$	48 dl
Humidity	JIS C 5202 7.5;	1,000 hours; 40±2 °C; 93(+2/–3)% RH	R < MΩ: ±(1.0%+0.05 Ω) R ≥ MΩ: ±(1.5%+0.05 Ω)	
(steady state)	IEC 60115-8 4.24.8	RCWV applied for 1.5 hours on and 0.5 hour off		
Leaching	EIA/IS 4.13B;	Solder bath at 260±5 °C	No visible damage	
	IEC 60115-8 4.18	Dipping time: 30±1 seconds		
Intermittent Overload	JIS C 5202 5.8	At room temperature; 2.5 × RCWV applied for I second on and 25 seconds off; total 10,000 cycles	±(1.0%+0.05 Ω)	
Resistance to Vibration	On request	On request		
Moisture	MIL-STD-202F-method 106F;	42 cycles; total 1,000 hours	±(2.0%+0.05Ω)	
Resistance Heat	IEC 60115-1 4.24.2	Shown as Fig. 4	No visible damage	

Table 6 Criteria of rated continued working voltage and overload voltage

ТҮРЕ	TR0402	TR0603	TR0805	TR1206
Voltage (DC/unit: V); (AC/ unit: V _{rms})	100	100	300	500

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Product specification

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REVISION HISTORY

REVISION DATE CHANGE NOTIFICATION DESCRIPTION

Version 0 Oct 18, 2005 - First issue of this specification

